PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q85494

Hiroshi IWAKIRI, et al.

Appln. No.: 10/522,028

Group Art Unit: 1762

Confirmation No.: 1544

Examiner: Erma C. CAMERON

Filed: January 21, 2005

For:

CURABLE COMPOSITION AND SEALING METHOD FOR CERAMIC SIDING

BOARDS

DECLARATION UNDER 37 C.F.R. § 1.132

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

I, HIROSHI <u>IWAKIRI</u>, hereby declare and state:

THAT I am a citizen of Japan;

THAT I am one of the named inventors of the above-identified application;

THAT it has come to my attention that Example 4 of the above-identified application contains an error with respect to the amount employed in Example 4 of the polymer obtained in Synthesis Example 2.

I declare that Example 4 of the present application, in fact, was prepared by employing 70 parts by weight of the polymer obtained in Synthesis Example 2, instead of the 100 parts by weight of the polymer obtained in Synthesis Example 2 that appears in the description of Example 4 of the present application.

DECLARATION UNDER 37 C.F.R. § 1.132

U.S. Application No.: 10/522,028

Attorney Docket No.: Q85494

I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 28/04 / 2008

Hrroshi Iwakiri